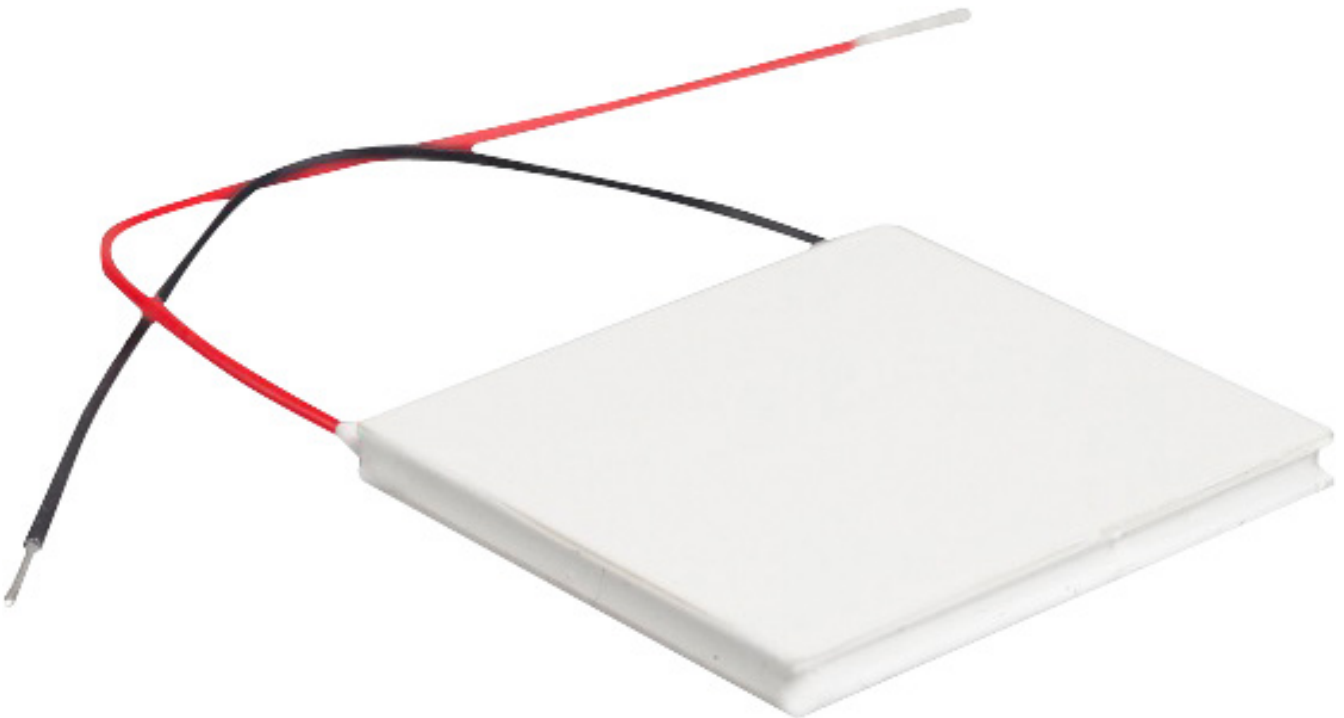


User Manual

Peltier Cooler Module with 127 Couples, 15.4V DC, 68.5W



Part Number: MPADV-127-150135-S

How to Fit a Thermoelectric Module in a System

Introduction

This guide describes the process of mounting a thermoelectric module for use in a thermal management or energy harvesting system. Considerations for mounting cooler (TEC) and generator (TEG) modules are outlined along with more general tips for achieving the maximum potential from your device.

Correct thermal coupling of a thermoelectric module is paramount for its function in a system, as the devices rely on thermal transfer through the module. Any limitations to the thermal transfer, for example additional thermal resistance/ impedance, will cause significant performance reductions. The most common interface at which thermal losses occur are between the heat exchangers and the ceramic faces of the module; best practice for these interfaces are outlined in this document.

Module Orientation

The first step, is to mount the module in the correct direction for the application. This is important as maximum temperature specifications can often differ for each side.

Determining hot and code side

Cooler modules (TEC)

Directly measure by operating the cooler module. Before doing this test, check the data sheet for the electrical power input characteristics of the device you are testing.

Connect the module to a power supply ensuring the polarity is correct, red wire to the positive terminal and black wire to the negative terminal. Momentarily apply a voltage to the device which is approximately 10% of the V_{max} value stated on the data sheet.

Important note: Do not apply full V_{max} at this stage because this could overheat the module.

Pinching the device between your index finger and thumb, a temperature differential will be felt. Take a note of which side is the cold and which side is the hot side. Terminate the power supply as soon as the temperature differential is observed.

Do not apply power for extended periods of time.

Generator Modules (TEG)

Directly measure by operating the module as a generator. Attach the wires to the corresponding coloured leads of a voltmeter and place the device on a surface that is likely to be at room temperature or less e.g. a table top. Place your hand on the side of the module which is facing up, this will simulate the module under a temperature differential as your hand should be warmer than the surface of the table. If a small positive voltage is recorded on the voltmeter, the hot side is the face touching your hand. If a small negative voltage is registered, then the cold side is the face that your hand is touching.

Note: Only a small voltage will be measured with this temperature difference so a suitable voltmeter should be used.

Heat Exchangers

A heat exchanger is normally required to couple the heat flux to and/or from the module. Commonly used heat exchangers are forced air convection or liquid based systems. Note that it is important to adequately size the heat exchanger to avoid too much temperature difference being dropped across the heat exchanger rather than the module. For example, heat sinks for natural convection in air typically result in significant performance losses unless they are significantly larger than the modules.

The impact of the heat exchangers can be estimated by examining the temperature difference across them, ΔT_{HEXC} , calculated from the estimated heat flow taken from the module datasheet, Q, and the thermal resistance of the heat exchanger, R_{HEXC} where:

$$\Delta T_{HEXC} = Q \cdot R_{HEXC}$$

Thermal Interfaces

The mating surfaces that thermally couple to the module via the interface material must be capable of good thermal coupling. We typically recommend a flatness ~0.05mm, and average roughness ~1.6 microns for best results.

Note: That this surface must also fulfil the clamping requirements discussed in later sections.

Thermal Grease

For operating conditions below 100°C thermal greases are commonly used as the interface material due to their high thermal conductivity and ability to fill any microscopic roughness at the interface. This type of interface material is often used for cooler modules and the cold side of generator modules to thermally couple them to a heat exchanger. The thermal grease is spread onto the ceramic surface of the modules to reduce the air gap caused by surface roughness, thus increasing surface contact area.

The key to achieving a good thermal joint between the module and heat exchanger is to use as little grease as possible while covering the whole area.

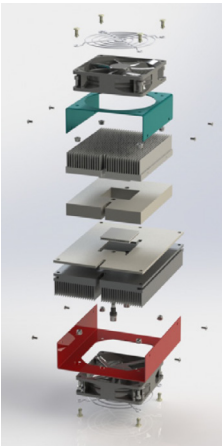


Image showing optimised thermoelectric assembly modelled in solid works

How to apply thermal grease:

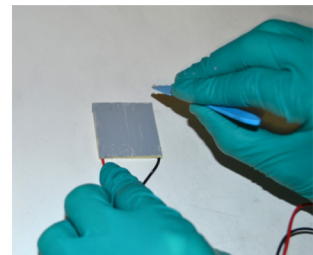
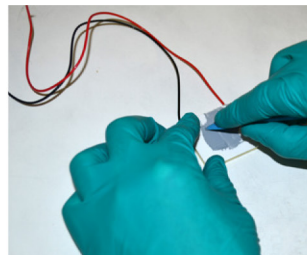
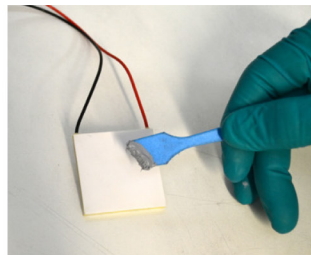
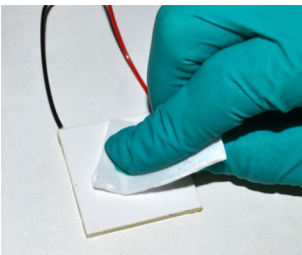
Step 1: Clean the surface of debris and grease with isopropanol (IPA) or a similar degreasing/solvent product.

Note: it is recommended to wear the appropriate protective clothing and gloves during this process.

Step 2. Apply a pea sized amount of thermal grease to the centre of the ceramic surface on the module.

Step 3. Use a plastic card or blade to spread the grease over the surface of the ceramic, ensuring no areas are uncovered.

Step 4. Do a final scrape to ensure even coverage and remove as much excess grease as possible.



Graphite Sheet

Thermal greases can dry out at higher temperatures especially in systems that require very long lifetimes. In these situations, graphite sheet materials can be used. Their thermal performance is approximately equivalent (<2% difference) to a thermal grease under adequate clamping pressures. Graphite sheets can be easily cut into shape before assembly, and easily removed, for example if used for test purposes only.

Graphite sheets with an added adhesive layer can be used to aid assembly, but note that they can lead to a 5-10% loss in module performance.

Gap Fillers

Gap fillers are often made from silicone and offer moderate thermal conductivities (1-5 W/mK). Their significant advantages lie in the complexity of shapes and patterns that they can be supplied in, including a greater tolerance to height variations; furthermore, they offer moderate protection to systems which are subject to vibrational forces.

However their thermal performance is typically lower than graphite sheets and greases, due to their higher thicknesses. These are therefore not typically recommended unless a thicker bond line is required, for example to cope with large tolerances or uneven mating surfaces.

Bonding Methods

With such direct bonding methods as described below, clamping may no longer be required.

Mechanical Bonding

A direct mechanical bonding method can be used to permanently attach the hot side of the module to the heat sink for improved thermal contact and simplification of assembly. However this introduces additional thermal stresses on the module due to thermal expansion mismatches so is not typically recommended, and should only be used with modules <20mm in size.

Thermally Conductive Adhesive

To mount with a thermally conductive adhesive, the steps are similar to the method explained when applying thermal grease. When mounting the hot side, apply a thin layer and mate the face with the heat exchanger. When curing, apply pressure to the joint to minimise the bond line and remove excess adhesive. Cure according to the manufacturer's guidelines.

Soldering

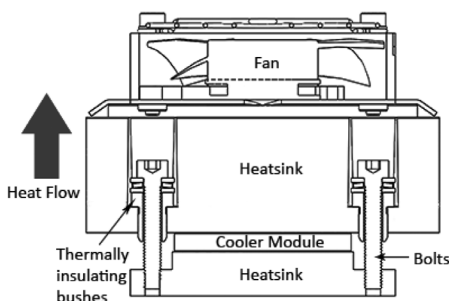
Modules with exterior metalisation can be mounted using regular methods like thermal grease or gap fillers, but they also enable the user to directly bond the module to the heat exchanger by soldering. A solder must be used which is of a lower melting temperature in comparison to that used within the thermoelectric module. For example a low temperature solder such as 118C InSn can be used. Pre-tinning of the heat exchanger and metallisation areas on the module is necessary prior to the final joining stage. When soldering the module to the heat exchanger, ensure a flux is used for optimal bonding and a pressure is applied during the soldering process and in the cooling stages to minimise the bond line.

Module Clamping and Assembly

The final stage of implementing a thermoelectric module into your system is the clamping and system assembly stage. It is important to achieve sufficient clamping and maintain thermal isolation for the surrounding components to achieve maximum performance from the device. Failure to clamp a thermoelectric module sufficiently can lead to performance losses of ~20% or more.

See diagram for an example of a thermoelectric cooler system. The thermoelectric module is situated between hot side and cold side heatsinks, in full contact with each. Compression is applied to the module via bolts evenly spaced from the the same rate until they reach optimum clamping torque. The bolts are thermally insulated using plastic bushes, preventing thermal contact between the hot and cold side, reducing parasitic losses to the system.

This example is used to describe the three important factors in assembling a thermoelectric system: clamping load, even clamping, and reduction of parasitic thermal losses.



How to Clamp the Module

Thermoelectric modules require a clamping load of 0.5-1.2 MPa. To achieve this clamping load in a system, bolts are most commonly used which are tightened to a specific torque. To calculate the torque necessary to achieve the required clamping force, the following formula can be used:

Torque Formula

$$T = \frac{c \times D \times P \times A}{N}$$

Where:

c = Torque Coefficient
 D = Nominal Bolt Size (in. or m)
 P = Compression Pressure (Pa or psi)
 A = Total Module Footprint Area (in.² or m²)
 N = Number of Screws
 T = Torque per Screw (lb-in. or N-m)

Worked Example

$$\text{Torque per bolt} = T = \frac{0.2 \times 0.0052 \times 1200000 \times 0.040 \times 0.040}{4} = 0.050 \text{ Nm}$$

For example, considering the system in the example below, four M5 bolts are used to clamp a 40mm×40mm module. The bolts are applied un-lubricated and so their value of 'c' can be approximated at 0.2. The nominal bolt size 'D' is 5.2mm and we are aiming to achieve 1.2MPa clamping. Therefore:

Torque per bolt = 0.50N.m

Belleville washers are recommended to be used in conjunction with the bolts to allow for changes in compression as the system settles and to allow tolerance for thermal stresses in the system when in operation.

Tip: Clamp your system to the required amount and then (if possible) run in steady state for 60 minutes to allow the interface layers to relax. Check and re-torque the bolts if necessary to ensure sufficient clamping remains for the lifetime of the system in use.

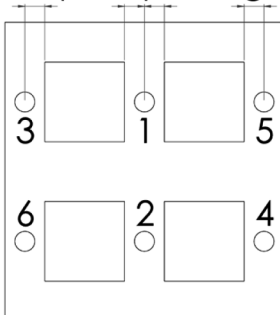
Clamping Sequence

To achieve even clamping and optimal thermal contact, it is recommended that care is taken during the bolt tightening stage to ensure an even load and turning rate is applied to each bolt. A bolt tightening sequence can be used for particular types of bolt patterns as shown in the diagram, opposing bolts are tightened to ensure even clamping is achieved.

Tightening in stages can be done by incrementally increasing the torque on each pass i.e. first pass – finger tight, second pass – 25% torque, third pass – 75% torque and 100% torque on final pass. Uneven clamping can cause poor thermal contact and damage to the thermoelectric module.

Finally, to reduce parasitic thermal losses in the system, plastic bolt bushes and insulating gaskets can be used. Plastic bolt bushes thermally isolate the hot and cold heat exchangers to reduce thermal losses along the clamping bolts. A thermally insulating foam gasket can be applied around the module which is clamped between the hot and cold heat exchangers to further reduce losses in the system.

Equal spacing



Multiple Modules

Multiple modules, and/or clamping plates covering large areas can increase the challenges of even clamping pressures on all modules. Can offer modules with a reduced height tolerance, for example by lapping modules to a pre-set height after production.

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